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Specification

MC42005B6W-SPR

DOC.	DATASHEET STATEMENT

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5. The sequence of the icons is random and doesn't indicate the importance grade.
6. Icons explanation

Midas 2006 version logo.Midas is an integrated manufacturer of flat panel display (FPD). Midas supplies TN, HTN, STN, FSTN monochrome LCD panel; COB, COG, TAB LCD module; and all kinds of LED backlight.

FAST RESPONSE TIME
This icon on the cover indicates the product is with high response speed; Otherwise not.

PROTECTION CIRCUIT
This icon on the cover indicates the product is with protection circuit; Otherwise not.

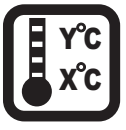
HIGH CONTRAST
This icon on the cover indicates the product is with high contrast; Otherwise not.

LONG LIFE VERSION
This icon on the cover indicates the product is long life version (over 9K hours guaranteed); Otherwise not.

WIDE VIEWING SCOPE
This icon on the cover indicates the product is with wide viewing scope; Otherwise not.

Anti UV VERSION
This icon on the cover indicates the product is against UV line. Otherwise not.

RoHS COMPLIANCE
This icon on the cover indicates the product meets ROHS requirements; Otherwise not.



OPERATION TEMPERATURE RANGE
This icon on the cover indicates the operating temperature range (X-Y).

3TIMEs 100% QC EXAMINATION
This icon on the cover indicates the product has passed Midas thrice 100% QC. Otherwise not.

TWICE SELECTION OF LED MATERIALS
This icon on the cover indicates the LED had passed Midas twice strict selection which promises the product's identical color and brightness; Otherwise not.

VIcm = 3.0V
This icon on the cover indicates the product can work at 3.0V exactly; otherwise not.

N SERIES TECHNOLOGY (2008 developed)
New structure, new craft, new technology and new materials inside both LCD module and LCD panel to improve the "RainBow"

DOCUMENT REVISION HISTORY:

DATE	PAGE	DESCRIPTION
1999.8.	-	First release
2005.3.	-	Modify the full specification
2005.12	-	Update the part number system
2006.03	-	Add Red backlight

MIDAS

Contents

1.Module Classification Information

2.Precautions in use of LCD Modules

3.General Specification

4.Absolute Maximum Ratings

5.Electrical Characteristics

6.Optical Characteristics

7.Interface Pin Function

8.Power Supply

9.Contour Drawing & Block Diagram

11.Function Description

12.Character Generator ROM Pattern

12.Instruction Table

13.Timing Characteristics

14.Initializing of LCM

15.Quality Assurance

16.Reliability

MIDAS

Midas LCD Part Number System

MC	COG	132033	A	*	6	W	*	*	-	S	N	T	L	W	*	*
1	2	3	4	5	6	7	8	9	-	10	11	12	13	14	15	16

1 = **MC:** Midas Components

2 = **Blank:** COB (chip on board) **COG**: chip on glass

3 = **No of dots** (e.g. 240064 = 240 x 64 dots) (e.g. 21605 = 2 x 16 5mm C.H.)

4 = **Series**

5 = **Series Variant:** A to Z

6 = **3:** 3 o'clock **6:** 6 o'clock **9**: 9 o'clock **12**: 12 o'clock

7 = **S**: Normal (0 to + 50 deg C) **W:** Wide temp. (-20 to + 70 deg C) **X:** Extended temp (-30 + 80 Deg C)

8 = **Character Set**

Blank: Standard (English/Japanese)
C: Chinese Simplified (Graphic Displays only)
CB: Chinese Big 5 (Graphic Displays only)
H: Hebrew
K: European (std) (English/German/French/Greek)
L: English/Japanese (special)
M: European (English/Scandinavian)
R: Cyrillic
W: European (English/Greek)
U: European (English/Scandinavian/Icelandic)

9 = **Bezel Height** (where applicable / available)

	Top of Bezel to Top of PCB	Common (via pins 1 and 2)	Array or Edge Lit
Blank	9.5mm / not applicable	Common	Array
2	8.9 mm	Common	Array
3	7.8 mm	Separate	Array
4	7.8 mm	Common	Array
5	9.5 mm	Separate	Array
6	7 mm	Common	Array
7	7 mm	Separate	Array
8	6.4 mm	Common	Edge
9	6.4 mm	Separate	Edge
A	5.5 mm	Common	Edge
B	5.5 mm	Separate	Edge

10 = **T:** TN **S**: STN **B:** STN Blue **G:** STN Grey **F:** FSTN **F2:** FFSTN

11 = **P:** Positive **N**: Negative

12 = **R:** Reflective **M**: Transmissive **T:** Transflective

13 = **Backlight: Blank:** Reflective **L:** LED

14 = **Backlight Colour: Y:** Yellow-Green **W:** White **B:** Blue **R:** Red **A:** Amber **O:** Orange **G:** Green **RGB:** R.G.B.

15 = **Driver Chip: Blank:** Standard **I:** I^2C

16 = **Voltage Variant**: e.g. **3** = 3v

2. Precautions in use of LCD Modules

(1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
(2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
(3)Don't disassemble the LCM.
(4)Don't operate it above the absolute maximum rating.
(5)Don't drop, bend or twist LCM.
(6)Soldering: only to the I/O terminals.
(7)Storage: please storage in anti-static electricity container and clean environment.

3. General Specification

Item	Dimension	Unit
Number of Characters	20characters x 4 Lines	—
Module dimension(No Backlight)	98.0 x 60.0 x 10.0（MAX）	mm
Module dimension(With LED Backlight)	98.0 x 60.0 x 15.0（MAX）	mm
View area	76.0 x 25.2	mm
Active area	70.40 x 20.80	mm
Dot size	0.55 x 0.55	mm
Dot pitch	0.60 x 0.60	mm
Character size	2.95 x 4.75	mm
Character pitch	3.55 x 5.35	mm
LCD type	STN	
Duty	1/16	
View direction	6 o'clock or 12 o'clock	
Backlight Type	Yellow/Green Reflective	

4. Absolute Maximum Ratings

Item		Symbol	Min	Max	Unit
Input Voltage		V_I	-0.3	VDD+0.3	V
Supply Voltage For Logic		VDD-V_{SS}	-0.3	7.0	V
Supply Voltage For LCD		V_{DD}-V_0	Vdd-13.5	0	V
Standard Temperature LCM	Operating Temp.	Top	0	50	℃
	Storage Temp.	Tstr	-10	60	℃
Wide Temperature LCM	Operating Temp.	Top	-20	70	℃
	Storage Temp.	Tstr	-30	80	℃

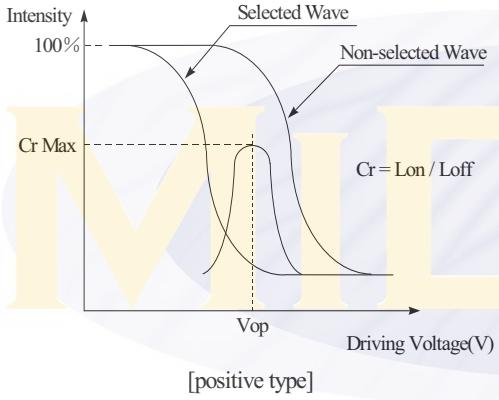
5. Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage For Logic	V_{DD}-V_{SS}	—	4.5	5.0	5.5	V
Supply Voltage For LCD	V_{DD}-V_0	Ta=25℃	4.5	5.0	5.5	V
Input High Volt.	V_{IH}	—	0.7 V_{DD}	—	V_{DD}	V
Input Low Volt.	V_{IL}	—	V_{SS}	—	0.3 V_{DD}	V
Supply Current	I_{DD}	V_{DD}=5V	0.7	0.75	1.5	mA
Supply Voltage of Yellow-green backlight	V_{LED}	Forward current =180 mA Number of LED die 2x18= 36	4.0	4.2	4.4	V
Supply Voltage of White backlight	V_{LED}	Forward current =30 mA Number of LED die 2	3.8	4.0	4.2	V
Supply Voltage of RED backlight	V_{LED}	Forward current =180 mA Number of LED die 2x18= 36	3.5	3.9	4.1	V

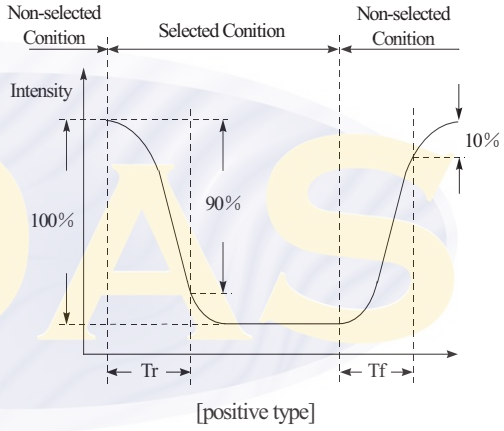
6. Optical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	(V)θ	CR≧2	-20	—	35	deg
	(H)φ	CR≧2	-30	—	30	deg
Contrast Ratio	CR	—	—	3	—	—
Response Time	T rise	—	—	—	250	ms
	T fall	—	—	—	250	ms

Definition of Operation Voltage (Vop)



Definition of Response Time (Tr , Tf)

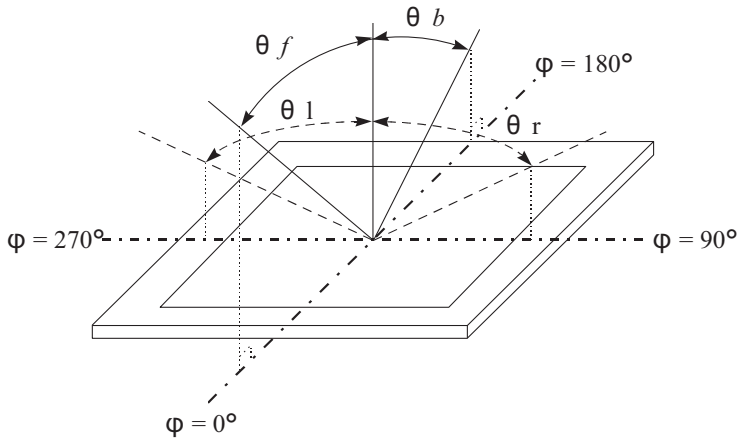


Conditions :

Operating Voltage : Vop　　Viewing Angle(θ，φ) : 0°， 0°

Frame Frequency : 64 HZ　　Driving Waveform : 1/N duty , 1/a bias

Definition of viewing angle(CR≧2)

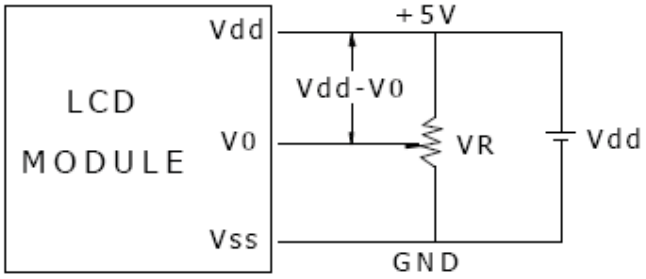


7. Interface Pin Function

Pin No.	Symbol	Level	Description
1	V_{SS}	0V	Ground
2	V_{DD}	5.0V	Supply Voltage for logic
3	V0	(Variable)	Operating voltage for LCD
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read(MPU→Module) L: Write(MPU→Module)
6	E	H,H→L	Chip enable signal
7	DB0	H/L	Data bit 0
8	DB1	H/L	Data bit 1
9	DB2	H/L	Data bit 2
10	DB3	H/L	Data bit 3
11	DB4	H/L	Data bit 4
12	DB5	H/L	Data bit 5
13	DB6	H/L	Data bit 6
14	DB7	H/L	Data bit 7
15	LED(+)		Anode of LED Backlight
16	LED(-)		Cathode of LED Backlight

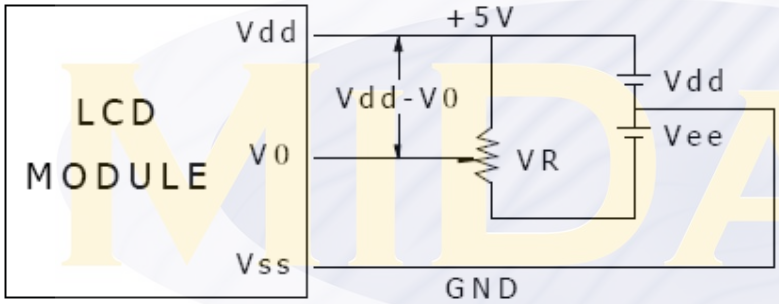
8. POWER SUPPLY

SINGLE SUPPLY VOLTAGE TYPE



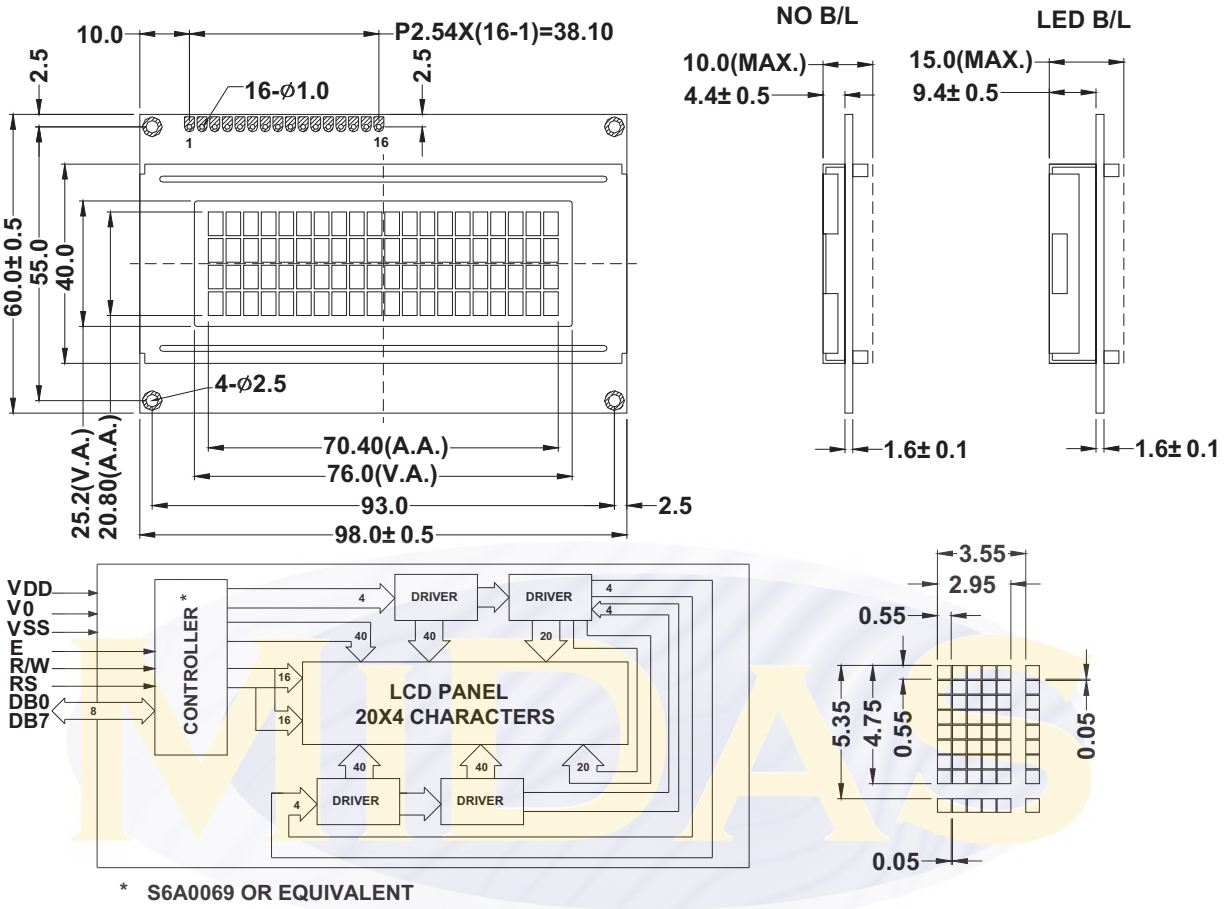
Vdd-V0: LCD Driving Voltage
VR: 10K - 20K

DUAL SUPPLY VOLTAGE TYPE



Vdd-V0: LCD Driving Voltage
VR: 10K - 20K

9. Contour Drawing &Block Diagram



10. Function Description

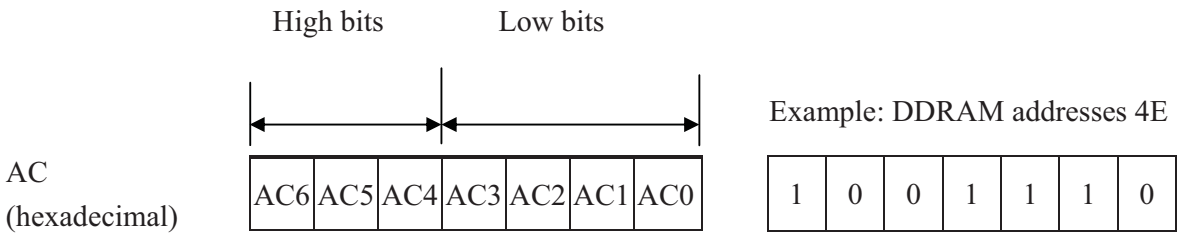
The LCD display Module is built in a LSI controller, the controller has two 8-bit registers, an instruction register (IR) and a data register (DR).
The IR stores instruction codes, such as display clear and cursor shift, and address information for display data RAM (DDRAM) and character generator (CGRAM). The IR can only be written from the MPU. The DR temporarily stores data to be written or read from DDRAM or CGRAM. When address information is written into the IR, then data is stored into the DR from DDRAM or CGRAM. By the register selector (RS) signal, these two registers can be selected.

RS	R/W	Operation
0	0	IR write as an internal operation (display clear, etc.)
0	1	Read busy flag (DB7) and address counter (DB0 to DB7)
1	0	Write data to DDRAM or CGRAM (DR to DDRAM or CGRAM)
1	1	Read data from DDRAM or CGRAM (DDRAM or CGRAM to DR)

Busy Flag (BF)
When the busy flag is 1, the controller LSI is in the internal operation mode, and the next instruction will not be accepted. When RS=0 and R/W=1, the busy flag is output to DB7. The next instruction must be written after ensuring that the busy flag is 0.

Address Counter (AC)
The address counter (AC) assigns addresses to both DDRAM and CGRAM

Display Data RAM (DDRAM)
This DDRAM is used to store the display data represented in 8-bit character codes. Its extended capacity is 80×8 bits or 80 characters. Below figure is the relationships between DDRAM addresses and positions on the liquid crystal display.



Display position DDRAM address

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F	10	11	12	13
40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F	50	51	52	53
80	81	82	83	84	85	86	87	88	89	8A	8B	8C	8D	8E	8F	90	91	92	93
C0	C1	C2	C3	C4	C5	C6	C7	C8	C9	CA	CB	CC	CD	CE	CF	D0	D1	D2	D3

4-Line by 20-Character Display

Character Generator ROM (CGROM)

The CGROM generate 5×8 dot or 5×10 dot character patterns from 8-bit character codes. See Table 2.

Character Generator RAM (CGRAM)

In CGRAM, the user can rewrite character by program. For 5×8 dots, eight character patterns can be written, and for 5×10 dots, four character patterns can be written.

Write into DDRAM the character code at the addresses shown as the left column of table 1. To show the character patterns stored in CGRAM.

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Relationship between CGRAM Addresses, Character Codes (DDRAM) and Character patterns

Table 1.

For 5 * 8 dot character patterns

Character Codes (DDRAM data)	CGRAM Address	Character Patterns (CGRAM data)	
7 6 5 4 3 2 1 0 (High Low)	5 4 3 2 1 0 (High Low)	7 6 5 4 3 2 1 0 (High Low)	
0 0 0 0 * 0 0 0	0 0 0	0 0 0	Character pattern(1)
		1 1 1	Cursor pattern
0 0 0 0 * 0 0 1	0 0 1	0 0 0	Character pattern(2)
		1 1 1	Cursor pattern
		0 0 0	
		0 0 1	
0 0 0 0 * 1 1 1	1 1 1	1 0 0	
		1 0 1	
		1 1 0	
		1 1 1	

For 5 * 10 dot character patterns

Character Codes (DDRAM data)	CGRAM Address	Character Patterns (CGRAM data)	
7 6 5 4 3 2 1 0 (High Low)	5 4 3 2 1 0 (High Low)	7 6 5 4 3 2 1 0 (High Low)	
0 0 0 0 * 0 0 0	0 0	0 0 0 0	Character pattern
		1 0 1 0	Cursor pattern
		1 1 1 1	

■ : " High "

11. Character Generator ROM Pattern

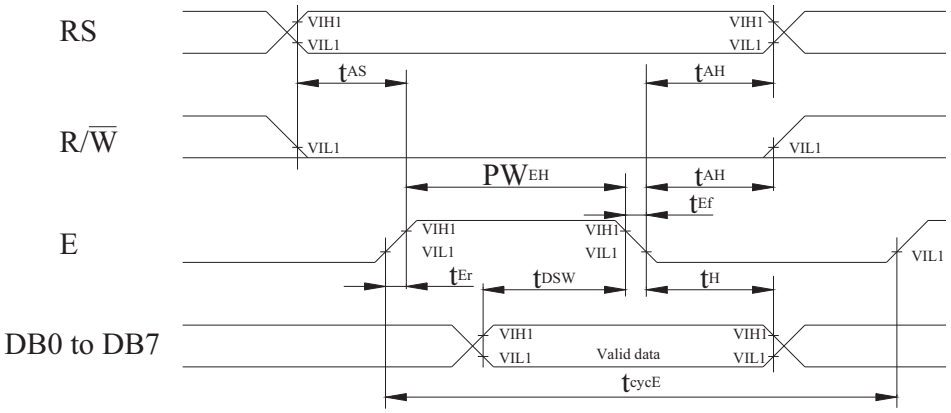
12. Instruction Table

Instruction	Instruction Code										Description	Execution time (fosc=270Khz)
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
Clear Display	0	0	0	0	0	0	0	0	0	1	Write “00H” to DDRAM and set DDRAM address to “00H” from AC	1.53ms
Return Home	0	0	0	0	0	0	0	0	1	—	Set DDRAM address to “00H” from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and enable the shift of entire display.	39μs
Display ON/OFF Control	0	0	0	0	0	0	1	D	C	B	Set display (D), cursor (C), and blinking of cursor (B) on/off control bit.	39μs
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	—	—	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	39μs
Function Set	0	0	0	0	1	DL	N	F	—	—	Set interface data length (DL:8-bit/4-bit), numbers of display line (N:2-line/1-line)and, display font type (F:5×11 dots/5×8 dots)	39μs
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	39μs
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter.	39μs
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0μs
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	43μs
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	43μs

＊ ”—”：don’t care

13. Timing Characteristics

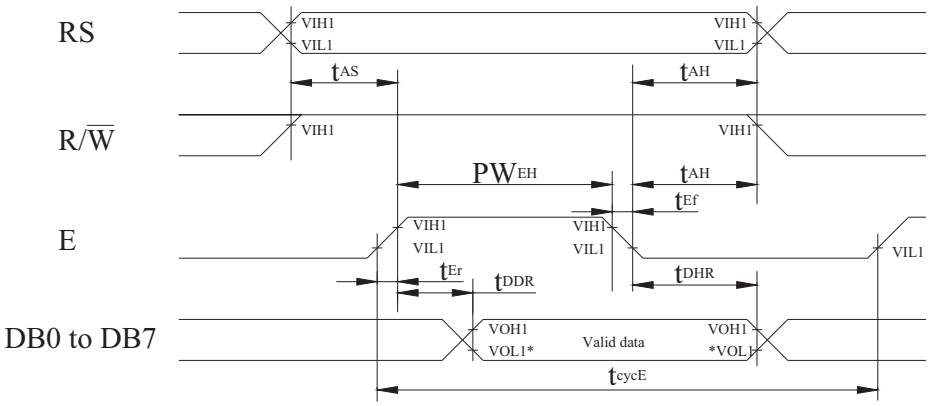
13.1 Write Operation



Ta=25℃, VDD=5.0± 0.5V

Item	Symbol	Min	Typ	Max	Unit
Enable cycle time	t_{cycE}	1200	—	—	ns
Enable pulse width (high level)	PW_{EH}	140	—	—	ns
Enable rise/fall time	t_{Er},t_{Ef}	—	—	25	ns
Address set-up time (RS, R/W to E)	t_{AS}	0	—	—	ns
Address hold time	t_{AH}	10	—	—	ns
Data set-up time	t_{DSW}	40	—	—	ns
Data hold time	t_{H}	10	—	—	ns

13.2 Read Operation



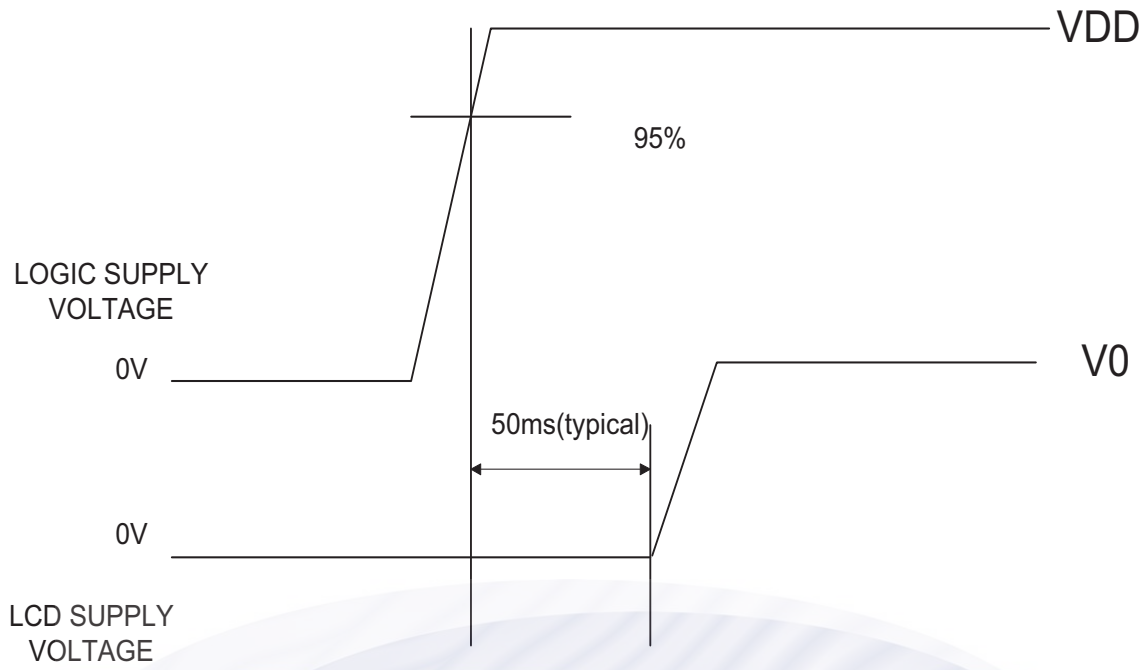
NOTE: *VOL1 is assumed to be 0.8V at 2 MHZ operation.

Ta=25℃, VDD=5.0± 0.5V

Item	Symbol	Min	Typ	Max	Unit
Enable cycle time	t_{cycE}	1200	—	—	ns
Enable pulse width (high level)	PW_{EH}	140	—	—	ns
Enable rise/fall time	t_{Er},t_{Ef}	—	—	25	ns
Address set-up time (RS, R/W to E)	t_{AS}	0	—	—	ns
Address hold time	t_{AH}	10	—	—	ns
Data delay time	t_{DDR}	—	—	100	ns
Data hold time	t_{DHR}	10	—	—	ns

13.3 Timing Diagram of VDD Against V0.

Power on sequence shall meet the requirement of Figure 4, the timing diagram of VDD against V0.



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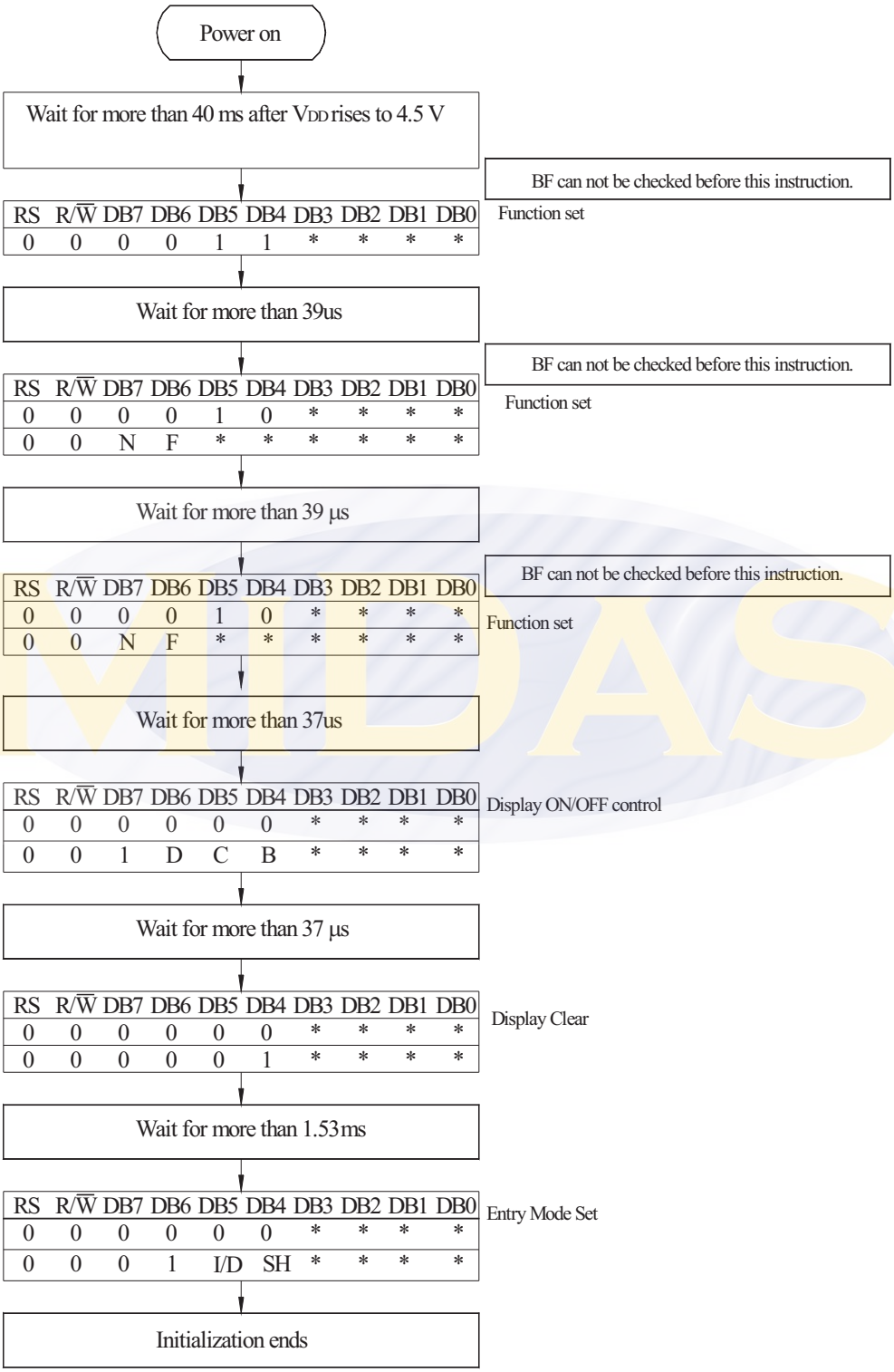
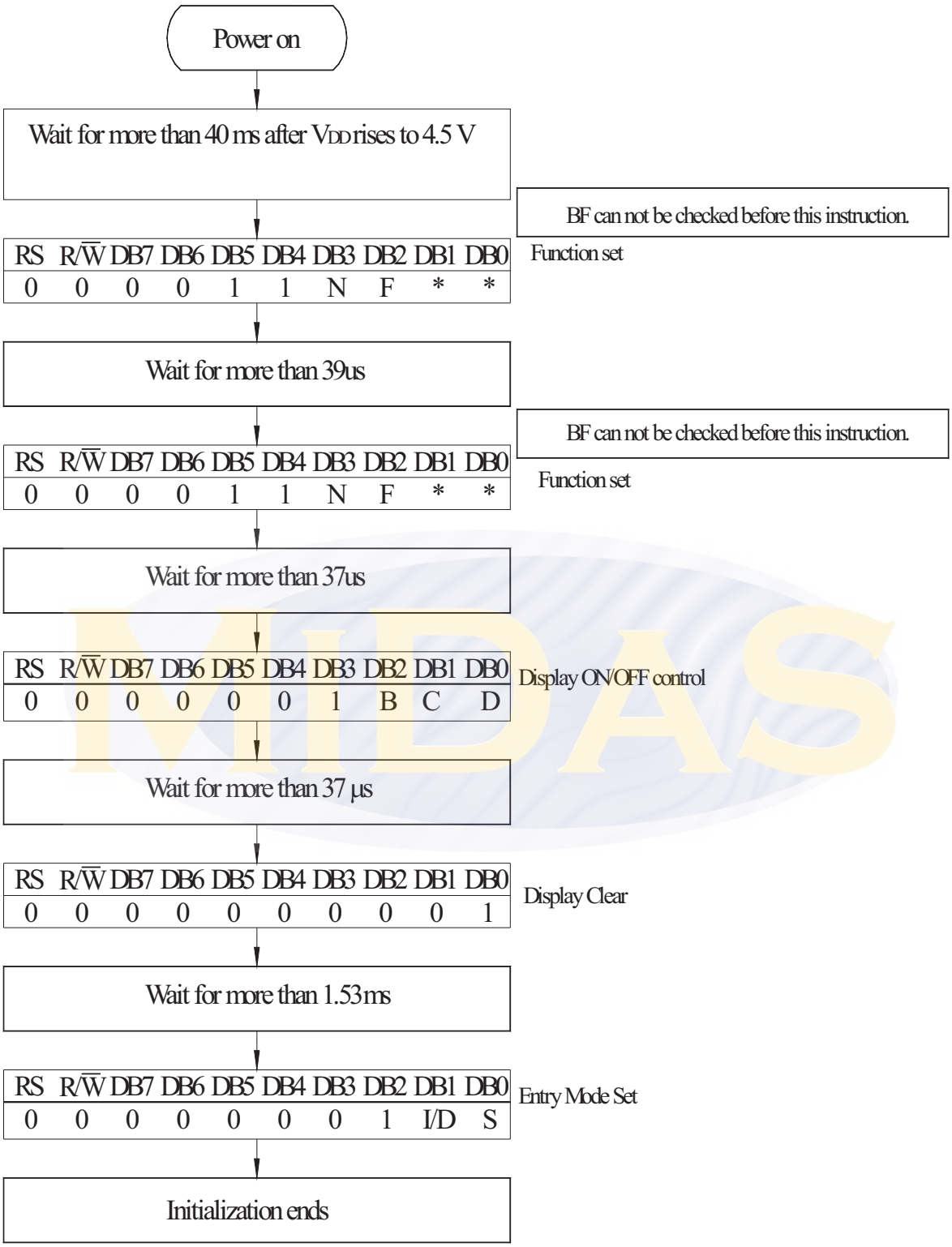
14.Initializing of LCM



4-Bit Ineterface



8-Bit Ineterface

15.Quality Assurance

Screen Cosmetic Criteria

Item	Defect	Judgment Criterion	Partition
1	Spots	A)Clear Size: d mm — Acceptable Qty in active area d ≦0.1 — Disregard 0.1<d≦0.2 — 6 0.2<d≦0.3 — 2 0.3<d — 0 Note: Including pin holes and defective dots which must be within one pixel size. B)Unclear Size: d mm — Acceptable Qty in active area d ≦0.2 — Disregard 0.2<d≦0.5 — 6 0.5<d≦0.7 — 2 0.7<d — 0	Minor
2	Bubbles in Polarizer	Size: d mm — Acceptable Qty in active area d≦0.3 — Disregard 0.3<d≦1.0 — 3 1.0<d≦1.5 — 1 1.5<d — 0	Minor
3	Scratch	In accordance with spots cosmetic criteria. When the light reflects on the panel surface, the scratches are not to be remarkable.	Minor
4	Allowable Density	Above defects should be separated more than 30mm each other.	Minor
5	Coloration	Not to be noticeable coloration in the viewing area of the LCD panels. Back-light type should be judged with back-light on state only.	Minor

16.Reliability

Content of Reliability Test

Environmental Test			
Test Item	**Content of Test**	**Test Condition**	**Applicable Standard**
High Temperature storage	Endurance test applying the high storage temperature for a long time.	60℃ 96hrs	——
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-10℃ 96hrs	——
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	50℃ 96hrs	——
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	0℃ 96hrs	——
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60℃,90%RH 96hrs	——
High Temperature/ Humidity Operation	Endurance test applying the electric stress (Voltage & Current) and temperature / humidity stress to the element for a long time.	50℃,90%RH 96hrs	——
Temperature Cycle	Endurance test applying the low and high temperature cycle. -10℃ 25℃ 60℃ 30min 5min 30min 1 cycle	-10℃/60℃ 10 cycles	——
Mechanical Test			
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hrs	——
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sign wave 11 msedc 3 times of each direction	——

***Supply voltage for logic system=5V. Supply voltage for LCD system =Operating voltage at 25℃